Electronic Acknowledgement Receipt					
EFS ID:	5142468				
Application Number:	10524525				
International Application Number:					
Confirmation Number:	1134				
Title of Invention:	Method for selectively removing material from the surface of a substrate, masking material for a wafer, and wafer with masking material				
First Named Inventor/Applicant Name:	Martin Hausner				
Customer Number:	26875				
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	BEET-09_US_IDS_FormSB_08 a_3rdSupp.pdf	617000 daaa565e1ce2525021f9511d8aaf70d81c17 1398	no	4

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3	Foreign Reference	JP8148468.PDF	700448	no	7
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